

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2650410

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>YOUNG JU KIM</td> <td>12/10/2013</td> </tr> <tr> <td>KWAN WEON KIM</td> <td>12/10/2013</td> </tr> <tr> <td>DONG UK LEE</td> <td>12/10/2013</td> </tr> </tbody> </table>		Name	Execution Date	YOUNG JU KIM	12/10/2013	KWAN WEON KIM	12/10/2013	DONG UK LEE	12/10/2013
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<table border="1"> <tr> <td>Name:</td> <td>SK HYNIX INC.</td> </tr> <tr> <td>Street Address:</td> <td>2091, GYEONGCHUNG-DAERO, BUBAL-EUB</td> </tr> <tr> <td>City:</td> <td>ICHEON-SI GYEONGGI-DO</td> </tr> <tr> <td>State/Country:</td> <td>KOREA, REPUBLIC OF</td> </tr> </table>		Name:	SK HYNIX INC.	Street Address:	2091, GYEONGCHUNG-DAERO, BUBAL-EUB	City:	ICHEON-SI GYEONGGI-DO	State/Country:	KOREA, REPUBLIC OF
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CORRESPONDENCE DATA									
<p>Fax Number: (630)908-7653</p> <p>Phone: 6309087652</p> <p>Email: uspto.actions@wpapat.com</p> <p><i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i></p> <p>Correspondent Name: WILLIAM PARK & ASSOCIATES PATENT LTD.</p> <p>Address Line 1: 930 N. YORK ROAD, SUITE 201</p> <p>Address Line 4: HINSDALE, ILLINOIS 60521</p>									
ATTORNEY DOCKET NUMBER:	PA1460-0								
NAME OF SUBMITTER:	WOOCHOON W. PARK								
Signature:	/Woochoon W. Park/								
Date:	12/16/2013								

This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 2

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**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION
USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT**

Title of Invention	ADDRESS INPUT CIRCUIT OF SEMICONDUCTOR APPARATUS	
Declaration	<p>As the below named inventor(s), I hereby declare that: The declaration is directed to: <input checked="" type="checkbox"/> The attached application, or <input type="checkbox"/> United States application or PCT international application number <u>PCT/KR#####</u> filed on _____</p> <p>The above-identified application was made or authorized to be made by me. I believe that I am the original or an original joint inventor of a claimed invention in the application. I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years or both.</p>	
Assignment	<p>NOW, THEREFORE, in consideration of the sum of one dollar (\$1), the receipt whereof is acknowledge, and other good and valuable consideration, I, by these presents do sell, assign and transfer unto said assignee(s) <div align="center">[SK hynix Inc.]</div> <div align="center">[2091, Gyeongchung-daero, Bubal-eub, Icheon-si, Gyeonggi-do 467-734, Republic of Korea]</div> and the heirs, successors, assigns and legal representatives of the assignee(s) the full and exclusive right to the said invention in the United States and in its territorial possessions and in any and all foreign countries any and all improvements thereof, the entire rights, title and interest in and to any and all Patents which may be granted therefore in the United States. I hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue said United States Patent to said assignee(s), of the entire right, title, and interest in and to the same, for his sole use and for the use of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.</p> <p>I agree promptly upon request of the assignee(s), its heirs, successors, assigns and legal representatives of the assignee(s) to communicate any facts known to it respecting the patent and the invention set forth therein, and to execute and deliver without further compensation any power of attorney, Assignment, application, whether original, continuation, divisional or reissue, or other papers that may be necessary.</p> <p>I hereby covenant that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.</p> <p>I further covenant that assignee(s) will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to me and will testify as to the same in any litigation related thereto and will promptly execute and deliver to assignee(s) or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.</p>	
Legal Name Of Inventor	Inventor Name (First Middle LAST):	Young Ju KIM
	Inventor Signature:	<i>in young Kim</i>
	Date:	2013. 12. 10

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION
USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Legal Name Of Joint Inventor, If Any	Inventor Name (First Middle LAST):	Kwan Weon KIM
	Inventor Signature:	<i>Kwan Weon Kim</i>
	Date:	<i>2013.12.10</i>

Legal Name Of Joint Inventor, If Any	Inventor Name (First Middle LAST):	Dong UK LEE
	Inventor Signature:	<i>Lee Dong UK</i>
	Date:	<i>2013.12.10</i>